To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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NPN SILICON RF TRANSISTOR
2SC5015

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 4-PIN SUPER MINIMOLD (18)

FEATURES

- High f_T: f_T = 12 GHz TYP. @ V_{CE} = 3 V, I_C = 10 mA, f = 2 GHz
- Low noise and high gain
- Low voltage operation
- 4-pin super minimold (18) package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC5015	50 pcs (Non reel)	• 8 mm wide embossed taping
2SC5015-T1	3 kpcs/reel	• Pin 3 (Base), Pin 4 (Emitter) face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office.
The unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	V_{CBO}	9	V
Collector to Emitter Voltage	V_{CEO}	6	V
Emitter to Base Voltage	V_{EBO}	2	V
Collector Current	I_C	30	mA
Total Power Dissipation	P_{tot}	150	mW
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	–65 to +150	°C

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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(Previous No. P10394EJ2V0DS00)
Date Published June 2003 CP(K)
Printed in Japan

The mark ★ shows major revised points.

ELECTRICAL CHARACTERISTICS (T_A = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	I_{CBO}	V_{CB} = 5 V, I_E = 0 mA	–	–	0.1	μA
Emitter Cut-off Current	I_{EBO}	V_{EB} = 1 V, I_C = 0 mA	–	–	0.1	μA
DC Current Gain	h_{FE} Note 1	V_{CE} = 3 V, I_C = 10 mA	75	–	150	–
RF Characteristics						
Gain Bandwidth Product	f_T	V_{CE} = 3 V, I_C = 10 mA, f = 2 GHz	–	12	–	GHz
Insertion Power Gain	$\|S_{21e}\|^2$	V_{CE} = 3 V, I_C = 10 mA, f = 2 GHz	9	11	–	dB
Noise Figure	NF	V_{CE} = 3 V, I_C = 3 mA, f = 2 GHz	–	1.5	2.5	dB
Reverse Transfer Capacitance	C_{re} Note 2	V_{CB} = 3 V, I_E = 0 mA, f = 1 MHz	–	0.3	0.5	pF

Notes 1. Pulse measurement: PW ≤ 350 μs, Duty Cycle ≤ 2%

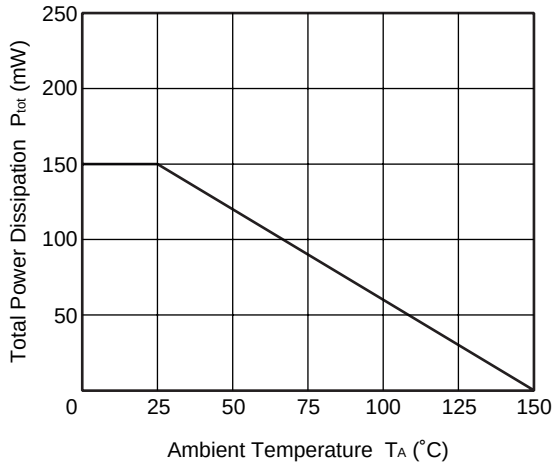
2. Collector to base capacitance when the emitter grounded

h_{FE} CLASSIFICATION

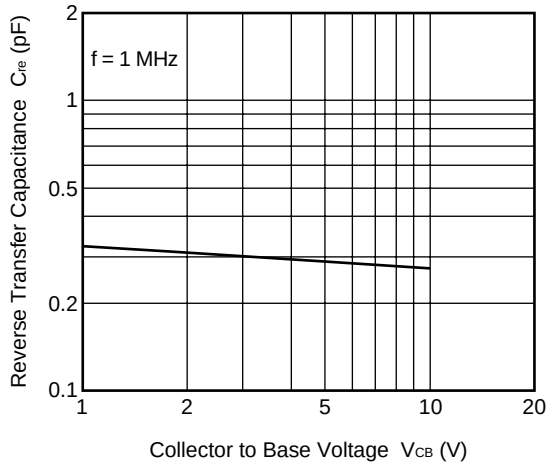
Rank	KB
Marking	T83
h_{FE} Value	75 to 150

★ **TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)**

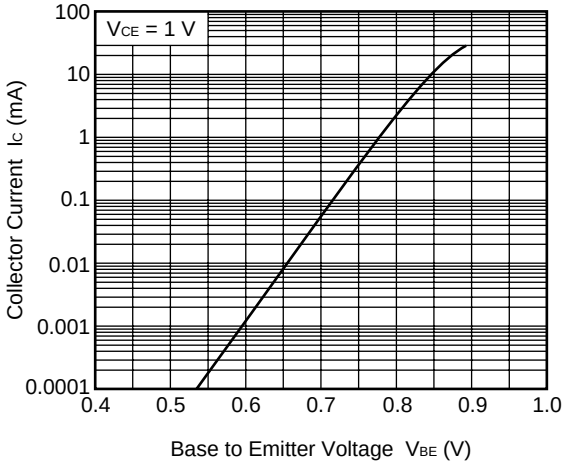
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



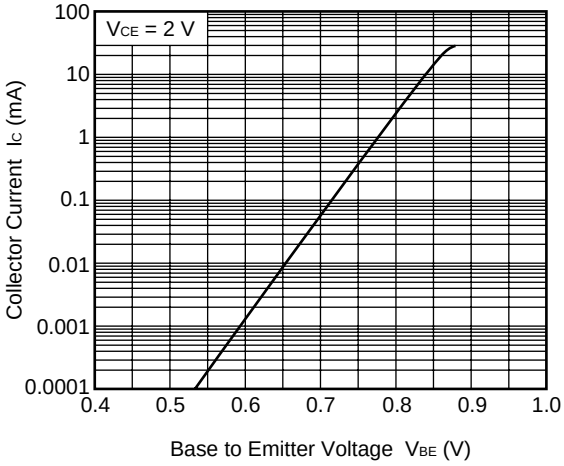
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



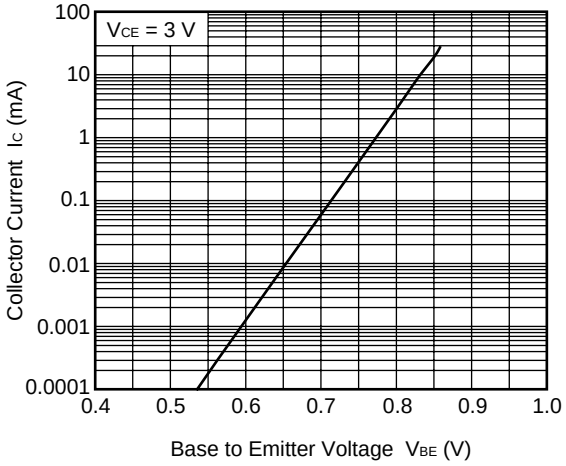
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



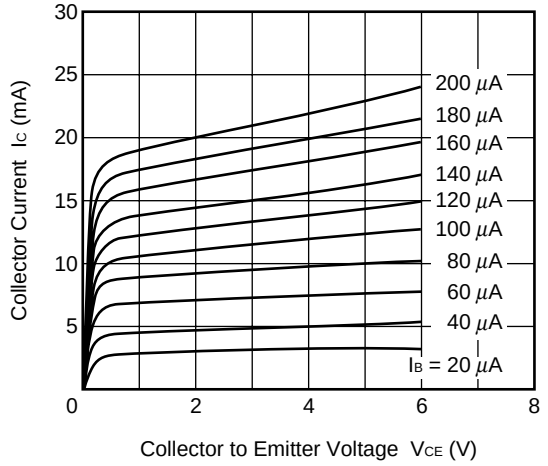
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



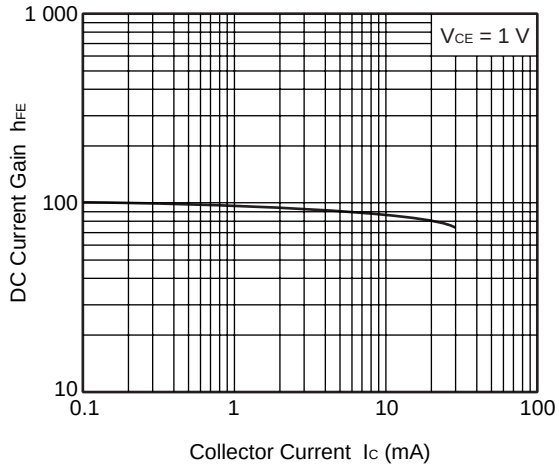
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



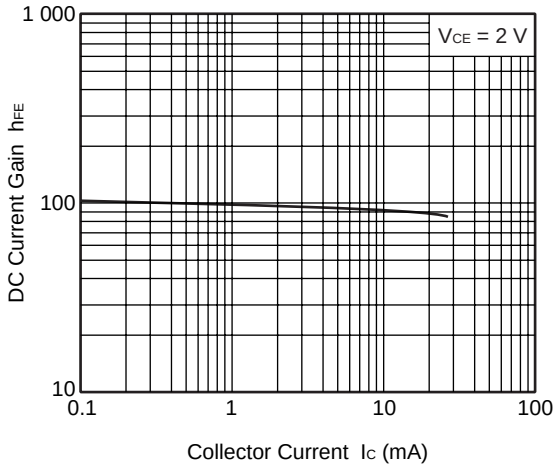
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



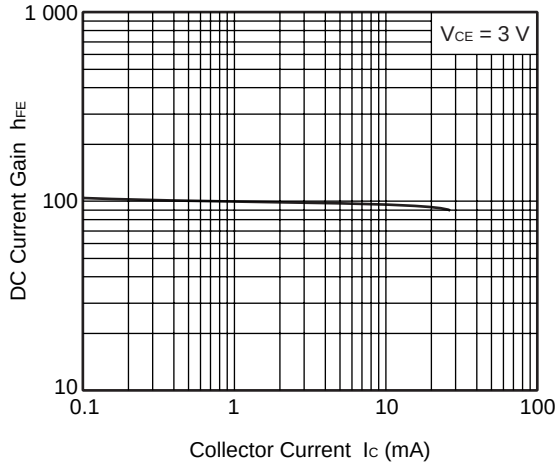
DC CURRENT GAIN vs.
COLLECTOR CURRENT



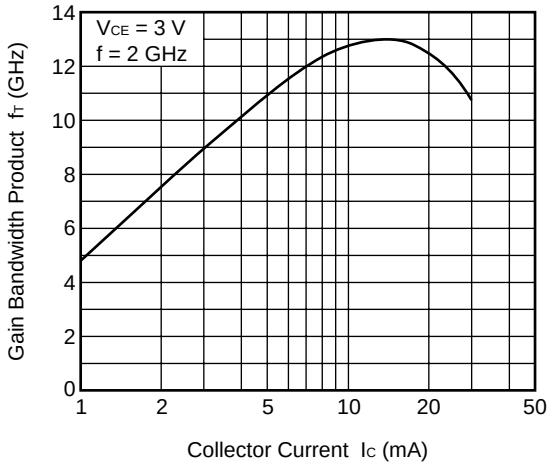
DC CURRENT GAIN vs.
COLLECTOR CURRENT



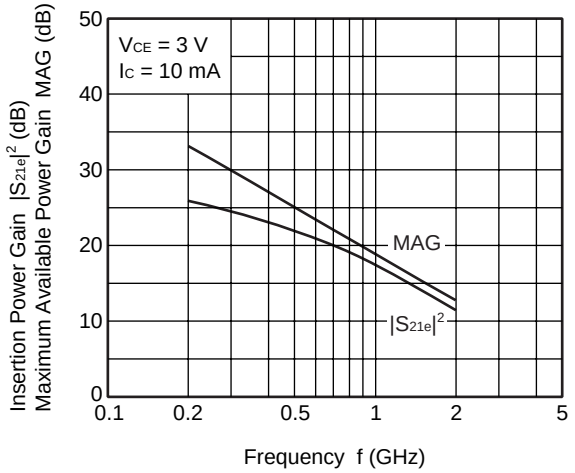
DC CURRENT GAIN vs.
COLLECTOR CURRENT



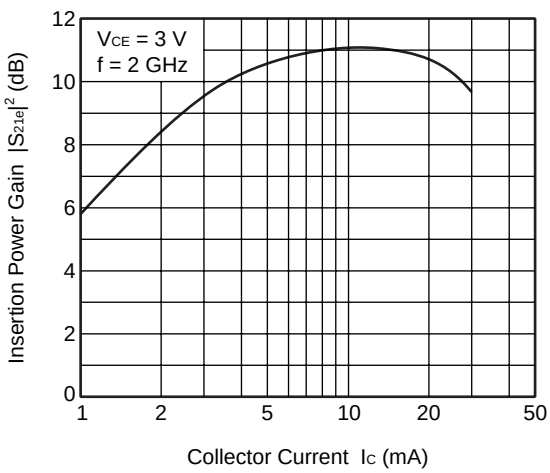
GAIN BANDWIDTH PRODUCT
vs. COLLECTOR CURRENT



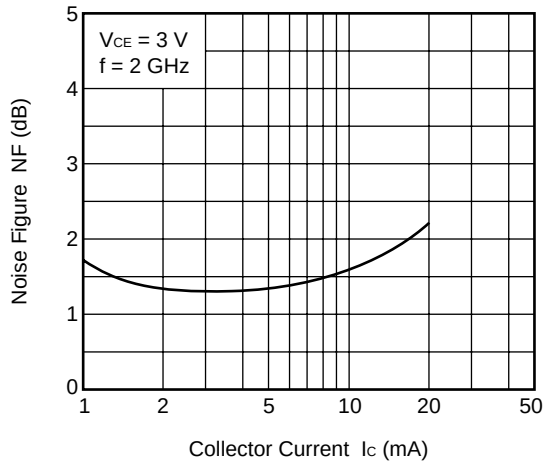
INSERTION POWER GAIN, MAG
vs. FREQUENCY



INSERTION POWER GAIN
vs. COLLECTOR CURRENT



NOISE FIGURE vs.
COLLECTOR CURRENT



Remark The graphs indicate nominal characteristics.

S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

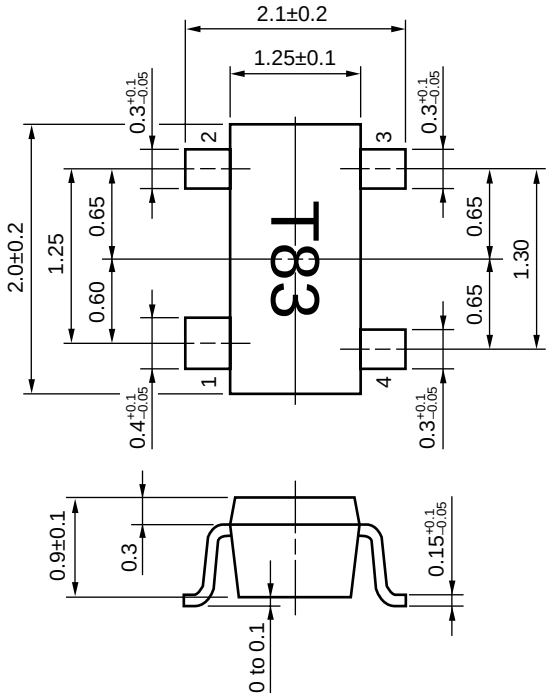
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL http://www.csd-nec.com/

PACKAGE DIMENSIONS

4-PIN SUPER MINIMOLD (18) (UNIT: mm)



PIN CONNECTIONS

1. Collector
2. Emitter
3. Base
4. Emitter

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